

MOSFET - Power, Single N-Channel, D2PAK-7L 650 V, 190 mΩ, 20 A

NVBG190N65S3F

Description

SUPERFET® III MOSFET is **onsemi's** brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET is very suitable for the various power system for miniaturization and higher efficiency. SUPERFET III FRFET® MOSFET's optimized reverse recovery performance of body diode can remove additional component and improve system reliability.

In addition, the D2PAK 7 lead package offers Kelvin sense. This allows higher switching speeds and gives designers the ability to reduce the overall application footprint.

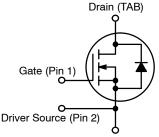
Features

- $700 \text{ V} @ \text{T}_{\text{J}} = 150^{\circ}\text{C}$
- Typ. $R_{DS(on)} = 158 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q_g = 36 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 339 pF)
- 100% Avalanche Tested
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Typical Applications

- Automotive On Board Charger
- Automotive DC/DC Converter for BEV

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
650 V	190 mΩ @ 10 V	20 A



Power Source (Pins 3, 4, 5, 6, 7)

N-CHANNEL MOSFET



D2PAK-7L CASE 418BJ

MARKING DIAGRAM

VBG190 N65S3F AYWWZZ

VBG190N65S3F = Specific Device Code

A = Assembly Location

Y = Year

WW = Work Week

ZZ = Lot Traceability

ORDERING INFORMATION

See detailed ordering and shipping information on page 6 of this data sheet.

Table 1. ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise stated)

Symbol	Parameter Drain-to-Source Voltage		Value	Unit
V _{DSS}			650	
V _{GS}	Gate-to-Source Voltage	- DC	±30	٧
		- AC (f > 1 Hz)	±30	1
I _D	Drain Current	– Continuous (T _C = 25°C)	20	Α
		– Continuous (T _C = 100°C)	12.7	1
I _{DM}	Drain Current	- Pulsed (Note 1)	50	Α
E _{AS}	Single Pulse Avalanche Energy (Note 2)		220	mJ
I _{AS}	Avalanche Current		2.8	Α
E _{AR}	Repeated Avalanche Energy (Note 1)		1.62	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		50	1
P _D	Power Dissipation	T _C = 25°C	162	W
		- Derate Above 25°C	1.3	W/°C
T _J , T _{stg}	Operating Junction and Storage Temperature Range		–55 to 150	°C
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
1. Repetitive rating: pulse – width limited by maximum junction temperature.
2. IAS = 3.2 A, RG = 25 Ω , starting T_J = 25°C.
3. ISD \leq 12 A, di/dt \leq 200 A/ μ s, V_{DD} \leq 400 V, starting T_C = 25°C.

Table 2. THERMAL RESISTANCE RATINGS

Symbol	Parameter	Max	Unit
$R_{ hetaJC}$	Thermal Resistance, Junction-to-Case, Max.	0.77	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.		

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARAC	CTERISTICS			•	•	•
BV _{DSS}	Drain-to-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}, T_J = 25^{\circ}\text{C}$	650	-	-	V
		$V_{GS} = 0 \text{ V}, I_D = 10 \text{ mA}, T_J = 150^{\circ}\text{C}$	700	-	-	V
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temperature Coefficient	I _D = 20 mA, Referenced to 25°C	-	0.61	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 650 V, V _{DS} = 0 V	1	-	10	μΑ
		V _{DS} = 520 V, T _C = 125°C	1	128	-	μΑ
I _{GSS}	Gate-to-Body Leakage Current	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}, T_J = 25^{\circ}\text{C}$	-	-	±100	nA
ON CHARAC	TERISTICS					
V _{GS(th)}	Drain-to-Source Breakdown Voltage	$V_{GS} = V_{DS}, I_D = 0.43 \text{ mA}$	3.0	-	5.0	V
R _{DS(on)}	Static Drain-to-Source On Resistance	V _{GS} = 10 V, I _D = 10 A	1	158	190	mΩ
9FS	Forward Transconductance	V _{GS} = 20 V, I _D = 10 A	1	11	-	S
DYNAMIC CH	IARACTERISTICS					
C _{iss}	Input Capacitance	V _{DS} = 400 V, V _{GS} = 0 V, f = 1 MHz	-	1710	-	pF
C _{oss}	Output Capacitance		-	34	-	pF
C _{oss(eff.)}	Effective Output Capacitance	V _{DS} = 0 to 400 V, V _{GS} = 0 V	-	339	-	pF
C _{oss(er.)}	Energy Related Output Capacitance	V _{DS} = 0 to 400 V, V _{GS} = 0 V	-	58	-	pF
Q _{g(total)}	Total Gate Charge at 10 V	$V_{DS} = 400 \text{ V}, I_{D} = 10 \text{ A},$	-	36	-	nC
Q_{gs}	Gate-to-Source Gate Charge	V _{GS} = 10 V (Note 4)	-	10.6	-	nC
Q_{gd}	Gate-to-Drain "Miller" Charge		-	14.5	-	nC
ESR	Equivalent Series Resistance	F = 1 MHz	-	1.7	-	Ω
SWITCHING	CHARACTERISTICS, V _{GS} = 10 V					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, I_D = 10 \text{ A},$	-	24	_	ns
t _r	Rise Time	V_{GS} = 10 V, R_{G} = 4.7 Ω (Note 4)	-	15.7	-	ns
t _{d(off)}	Turn-Off Delay Time		-	50	-	ns
t _f	Fall Time		ı	4.3	-	ns
SOURCE-DR	AIN DIODE CHARACTERISTICS					
IS	Maximum Continuous Source-to-Drain Diode Forward Current		-	-	20	Α
I _{SM}	Maximum Pulsed Source-to-Drain Diode Forward Current		-	-	50	Α
V _{SD}	Source-to-Drain Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 10 A	-	-	1.3	V
t _{rr}	Reverse-Recovery Time	V _{GS} = 0 V, I _{SD} = 10 A,	-	73	-	ns
Q _{rr}	Reverse-Recovery Charge	dI _F /dt = 100 A/μs	-	224	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.

TYPICAL CHARACTERISTICS

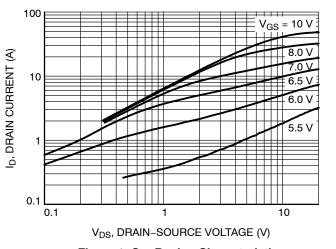


Figure 1. On-Region Characteristics

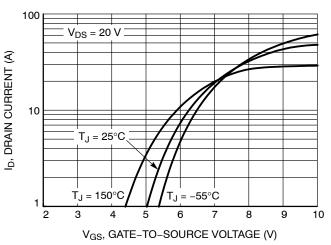


Figure 2. Transfer Characteristics

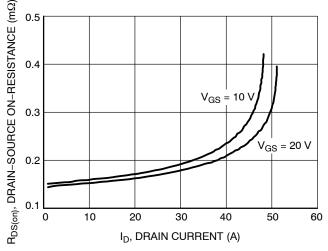


Figure 3. On–Resistance Variation vs. Drain Current and Gate Voltage

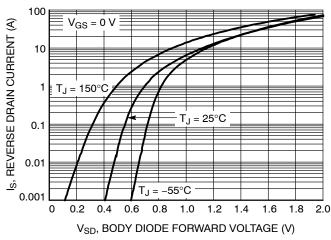


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

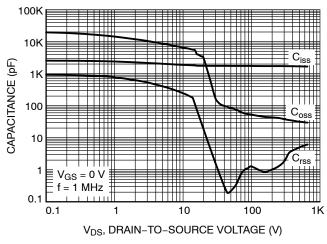


Figure 5. Capacitance Characteristics

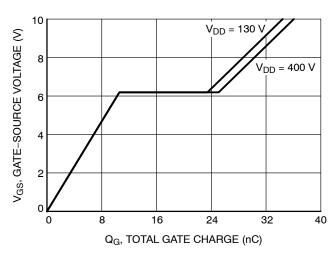


Figure 6. Gate Charge Characteristics

TYPICAL CHARACTERISTICS

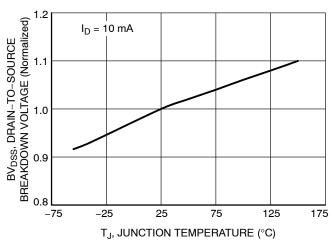


Figure 7. Breakdown Voltage Variation vs. Temperature

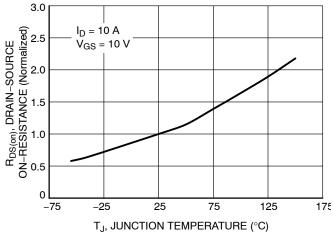


Figure 8. On–Resistance Variation vs.
Temperature

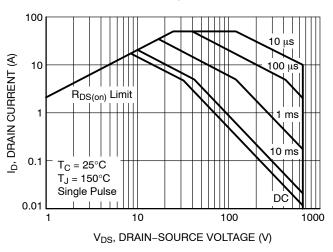


Figure 9. Maximum Safe Operating Area

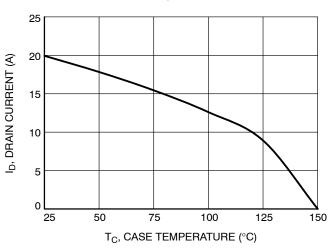


Figure 10. Maximum Drain Current vs. Case Temperature

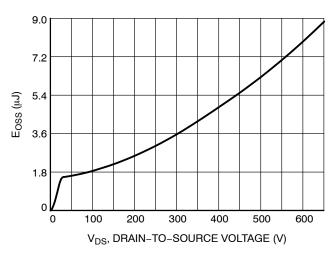


Figure 11. E_{OSS} vs. Drain-to-Source Voltage

TYPICAL CHARACTERISTICS

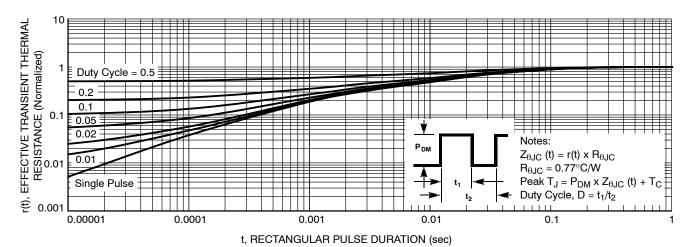


Figure 12. Transient Thermal Response

DEVICE ORDERING INFORMATION

Device	Package	Shipping [†]
NVBG190N65S3F	D2PAK-7L	800 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

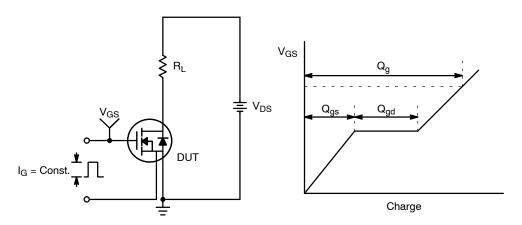


Figure 13. Gate Charge Test Circuit & Waveform

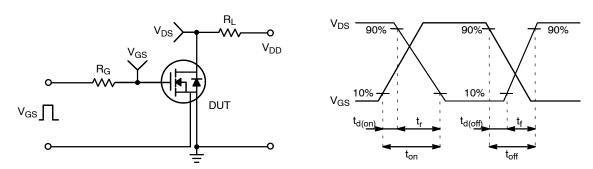


Figure 14. Resistive Switching Test Circuit & Waveforms

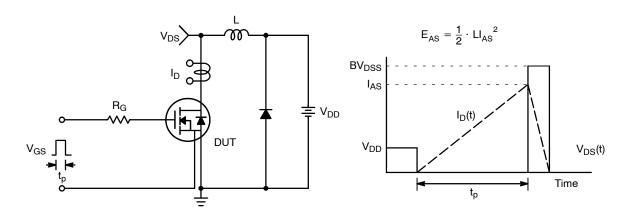


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

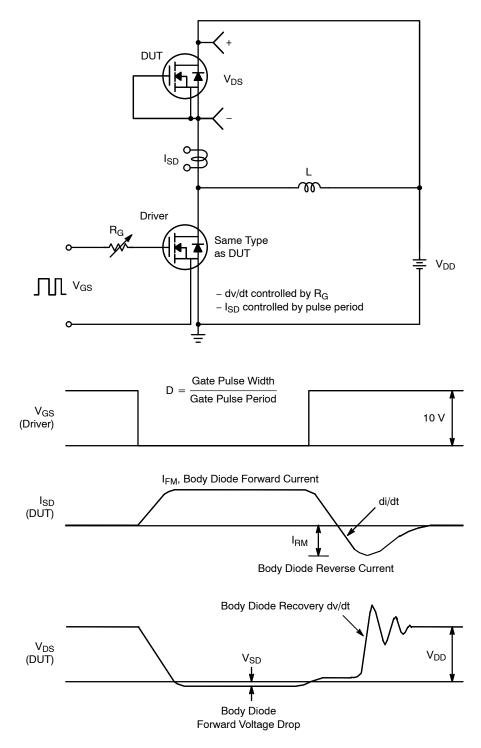
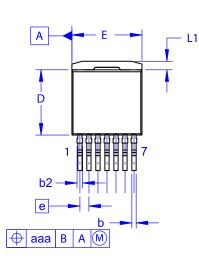
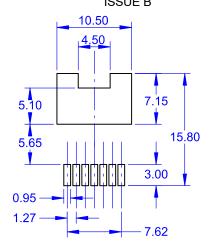


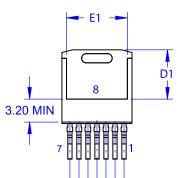
Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

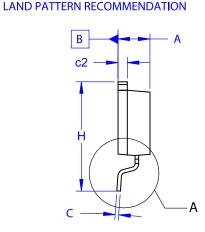
PACKAGE DIMENSIONS

D²PAK7 (TO-263-7L HV) CASE 418BJ ISSUE B







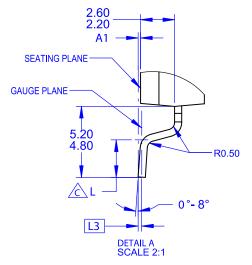


NOTES:

A. PACKAGE CONFORMS TO JEDEC TO-263 VARIATION CB EXCEPT WHERE NOTED. B. ALL DIMENSIONS ARE IN MILLIMETERS.

OUT OF JEDEC STANDARD VALUE.
D. DIMENSION AND TOLERANCE AS PER ASME Y14.5-2009.
E. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.

DIM	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	4.30	4.50	4.70	
A 1	0.00	0.10	0.20	
b2	0.60	0.70	0.80	
b	0.51	0.60	0.70	
С	0.40	0.50	0.60	
c2	1.20	1.30	1.40	
D	9.00	9.20	9.40	
D1	6.15	6.80	7.15	
Е	9.70	9.90	10.20	
E1	7.15	7.65	8.15	
е	~	1.27	~	
Н	15.10	15.40	15.70	
L	2.44	2.64	2.84	
L1	1.00	1.20	1.40	
L3	~	0.25	~	
aaa	~	~	0.25	



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